

IN THE SPECIFICATION:

Please replace the Abstract of the Disclosure with the following amended Abstract:

Technology to reduce the manufacturing cost of a manufacturing process of a light emitting device is provided. The manufacturing cost of a device using a light emitting element can be reduced by using a multilayout process for forming a plurality of light emitting devices from a large-sized substrate. In particular, ~~a remarkable feature of the present invention resides in a point that~~ an existing line for manufacturing liquid crystal cells can be diverted to a process of encapsulating light emitting elements ~~according to the present invention~~, which can greatly reduce the manufacturing cost including the investment in plant and equipment.